

Title (en)
Board separation assembly

Title (de)
Plattenaufteilanlage

Title (fr)
Installation de distribution de plaques

Publication
EP 2251131 B1 20170607 (DE)

Application
EP 10004559 A 20100430

Priority
AT 7462009 A 20090514

Abstract (en)
[origin: EP2251131A1] The arrangement has a saw unit (3) movable along a saw line (2) for sawing a workpiece (1). A feeding region (4) feeds the workpiece towards the saw line. An identification device (5) is arranged in the feeding region for applying an identifier i.e. label, on the workpiece. The identification device includes an applicator (6) movably mounted in the feeding region relative to the workpiece for fixing the label to the workpiece. The identification unit includes an applicator drive motor for processing the applicator in the feeding region. An independent claim is also included for a method for operating a board partitioning arrangement.

IPC 8 full level
B23D 59/00 (2006.01); **B27B 5/29** (2006.01); **B65C 1/02** (2006.01)

CPC (source: EP)
B27B 5/065 (2013.01); **B27B 5/29** (2013.01)

Cited by
CN105835130A; ITBO20130596A1; EP2286969A3; DE102009038122B4; EP3834976A1

Designated contracting state (EPC)
AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO SE SI SK SM TR

DOCDB simple family (publication)
EP 2251131 A1 20101117; EP 2251131 B1 20170607; AT 508165 A1 20101115; AT 508165 B1 20130515; ES 2636714 T3 20171006

DOCDB simple family (application)
EP 10004559 A 20100430; AT 7462009 A 20090514; ES 10004559 T 20100430